DSC4005

Silicon NPN epitaxial planar type

For general amplification
Complementary to DSA4005
DSC2005 in NS through hole type package

■ Features

- \bullet High forward current transfer ratio h_{FE} with excellent linearity
- \bullet Low collector-emitter saturation voltage $V_{\text{CE}(\text{sat})}$
- Contributes to miniaturization of sets, mount area reduction
- Eco-friendly Halogen-free package

■ Packaging

DSC4005×0A Radial type: 5000 pcs / carton

■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	60	V	
Collector-emitter voltage (Base open)	V _{CEO}	50	V	
Emitter-base voltage (Collector open)	V _{EBO}	6	V	
Collector current	$I_{\rm C}$	200	mA	
Peak collector current	I_{CP}	300	mA	
Collector power dissipation	$P_{\rm C}$	300	mW	
Junction temperature	T_j	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C _	

■ Package

Code

NS-B2-B-B

Package dimension clicks here. \rightarrow

- Pin Name
 - 1. Emitter
 - 2. Collector
 - 3. Base
- Marking Symbol: C3

■ Electrical Characteristics $T_a = 25$ °C±3°C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-emitter voltage (Base open)	V_{CEO}	$I_C = 100 \mu\text{A}, I_B = 0$	50			V
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 60 \text{ V}, I_{E} = 0$			0.1	μΑ
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 6 \text{ V}, I_{C} = 0$			0.1	μА
Forward current transfer ratio *1	h _{FE1} *2	$V_{CE} = 6 \text{ V}, I_{C} = 1 \text{ mA}$	150		390	
Forward current transfer ratio	h _{FE2}	$V_{CE} = 6 \text{ V}, I_{C} = 0.1 \text{ mA}$	90			_
Collector-emitter saturation voltage *1	V _{CE(sat)}	$I_C = 100 \text{ mA}, I_B = 10 \text{ mA}$			0.3	V
Transition frequency	f_T	$V_{CE} = 6 \text{ V}, I_{C} = 10 \text{ mA}$		150		MHz
Collector output capacitance (Common base, input open circuited)	C _{ob}	$V_{CB} = 6 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$		3.5		pF

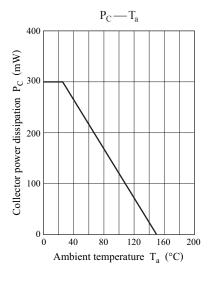
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

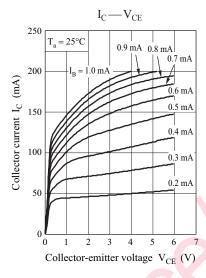
- 2. *1: Pulse measurement
 - *2: Rank classification

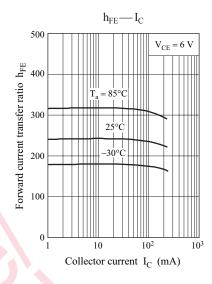
Code	R	S	0	
Rank	R	S	No-rank	
h_{FE1}	150 to 270	200 to 390	150 to 390	
Marking Symbol	C3R	C3S	C3	

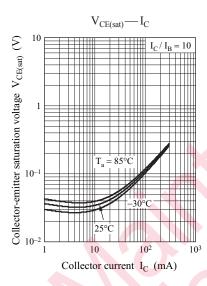
Product of no-rank is not classified and have no marking symbol for rank.

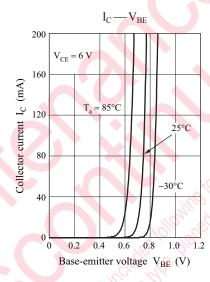
DSC4005 Panasonic

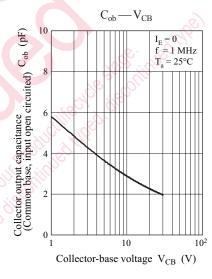


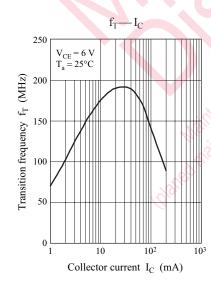












2 Ver. AED

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